## : ©hipsmall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation, and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!


## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
Email \& Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, \#122 Zhenhua RD., Futian, Shenzhen, China

## LED DISPLAY DRIVERS

## FEATURES SUMMARY

- M5450 34 OUTPUTS/15mA SINK
- M5451 35 OUTPUTS/15mA SINK
- CURRENT GENERATOR OUTPUTS (NO EXTERNAL RESISTORS REQUIRED)
- CONTINUOUS BRIGHTNESS CONTROL
- SERIAL DATA INPUT
- ENABLE (ON M5450)
- WIDE SUPPLY VOLTAGE OPERATION
- TTL COMPATIBILITY


## Application Examples:

- MICROPROCESSOR DISPLAYS
- INDUSTRIAL CONTROL INDICATOR
- RELAY DRIVER
- INSTRUMENTATION READOUTS


## DESCRIPTION

The M5450 and M5451 are monolithic MOS integrated circuits produced with an N-cr ar n $\dagger$ ! silicon gate technology. They are available in .0-pin dual in-line plastic packages.
A single pin controls the LF- dis play brightness by setting a reference suri r. $^{+}+$arough a variable resistor connected to IUD Cr to a separate supply of 13.2V maximum..

Figure 1. Packages


PDIP40
(Plastic Package)


PLCC44
(Plastic Chip Carrier)

Figure 2. Pin Connection


Figure 3. Block Diagram


Table 1. Absolute Maximum Ratings

| Symbol | Parameter | Value | Unit |
| :---: | :--- | :---: | :---: |
| $\mathrm{V}_{\mathrm{DD}}$ | Supply Voltage | -0.3 to 15 | V |
| $\mathrm{~V}_{\mathrm{I}}$ | Input Voltage | -0.3 to 15 | V |
| $\mathrm{~V}_{\text {O(off) }}$ | Off State Output Voltage | 15 | V |
| $\mathrm{IO}_{\mathrm{O}}$ | Output Sink Current | 40 | mA |
| $\mathrm{P}_{\text {TOT }}$ | Total Package Power Dissipation at $25^{\circ} \mathrm{C}$ | 1 | W |
|  | Total Package Power Dissipation at $85^{\circ} \mathrm{C}$ | 560 | mW |
| $\mathrm{~T}_{\mathrm{j}}$ | Junction Temperature | 150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{OP}}$ | Operating Temperature Range | -25 to 85 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {STG }}$ | Storage Temperature Range | -65 to 150 | ${ }^{\circ} \mathrm{C}$ |

Note: Stresses above those listed under "Absolute Maximum Ratings" may causes permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## FUNCTIONAL DESCRIPTION

Both the M5450 and the M5451 are specially designed to operate 4 or 5-digit alphanumeric displays with minimal interface with the display and the data source. Serial data transfer from the data source to the display driver is accomplished with 2 signals, serial data and clock. Using a format of a leading "1" followed by the 35 data bits allows data transfer without an additional load signal. The 35 data bits are latched after the 36th bit is complete, thus providing non-multiplexed, direct drive to the display.
Outputs change only if the serial data bits differ from the previous time.
Display brightness is determined by control of the output current LED displays.
A 1 nF capacitor should be connected to brightness control, pin 19, to prevent possible oscillations.
A block diagram is shown in Figure 3. For the M5450 a DATA ENABLE is used instead of the 35th output. The DATA ENABLE input is a metal option for the M5450.
The output current is typically 20 times greater than the current into pin 19, which is set by an external variable resistor. There is an internal limiting resistor of 400W nominal value.
Figure 4 shows the input data format. A start bit of logical "1" precedes the 35 bits of data. At the 36th clock a LOAD signal is generated synchronously with the high state of the clock, which loads the 35 bits of the shift registers into the latches.
At the low state of the clock a RESET signal is generated which clears all the shift registers for the next set of data. The shift registers are static
master-slave configurations. There is no clear for the master portion of the first shift register, thus allowing continuous operation.
There must be a complete set of 36 clocks or the shift registers will not clear.
When power is first applied to the chip an internal power ON reset signal is generated which resets all registers and all latches. The START bit and the first clock return the chip to its normal operation.
Bit 1 is the first bit following the start bit and it will appear on Pin 18. A logical "1" at the input will turn on the appropriate LED.
Figure 5 shows the timing relationship between Data, Clock and DATA ENABLE.
A max clock frequency of 0.5 MHz is assumed. For applications where a lesser number of outputs are used, it is possible to either increase the current per output or operate the part at higher than 1V Vout.
The following equation can be used for calculations.
$\mathrm{T}_{\mathrm{j}}=\left[\left(\mathrm{V}_{\text {OUT }}\right)\left(\mathrm{I}_{\text {LED }}\right)(\right.$ No. of segments $)+\left(\mathrm{V}_{\mathrm{DD}} \times\right.$ $7 \mathrm{~mA})]\left(124^{\circ} \mathrm{C} / \mathrm{W}\right)+\mathrm{T}_{\mathrm{amb}}$
where :
$\mathrm{T}_{\mathrm{j}}=$ junction temperature $\left(150^{\circ} \mathrm{C}\right.$ max $)$
$V_{\text {OUT }}=$ the voltage at the LED driver outputs
lLED = the LED current
$124^{\circ} \mathrm{C} / \mathrm{W}=$ thermal coefficient of the package
$\mathrm{T}_{\mathrm{amb}}=$ ambient temperature
The above equation was used to plot Figure 6, Figure 7 and Figure 8.

Table 2. Static Electrical Characteristics
( $\mathrm{T}_{\mathrm{amb}}$ within operating range, $\mathrm{V}_{\mathrm{DD}}=4.75 \mathrm{~V}$ to $13.2 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}$, unless otherwise specified)

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{\text {DD }}$ | Supply Voltage |  | 4.75 |  | 13.2 | V |
| IDD | Supply Current | $\mathrm{V}_{\mathrm{DD}}=13.2 \mathrm{~V}$ |  |  | 7 | mA |
| $\mathrm{V}_{1}$ | Input Voltage Logical "0" Level Logical "1" Level | $\begin{aligned} & \hline \pm 10 \mu \mathrm{~A} \text { Input Bias } \\ & 4.75 \leq \mathrm{V}_{\mathrm{DD}} \leq 5.25 \\ & \mathrm{~V}_{\mathrm{DD}}>5.25 \end{aligned}$ | $\begin{gathered} \hline-0.3 \\ 2.2 \\ V_{D D}-2 \end{gathered}$ |  | $\begin{gathered} \hline 0.8 \\ V_{D D} \\ V_{D D} \end{gathered}$ | $\begin{aligned} & \hline \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \end{aligned}$ |
| IB | Brightness Input Current (note 2) |  | 0 |  | 0.75 | mA |
| $\begin{gathered} \mathrm{V}_{\mathrm{B}} \\ \mathrm{~V}_{\mathrm{O}(\text { off })} \end{gathered}$ | Brightness Input Voltage (pin 19) Off State Out. Voltage | Input Current $=750 \mu \mathrm{~A}, \mathrm{~T}_{\mathrm{amb}}=25^{\circ} \mathrm{C}$ | 3 |  | $\begin{gathered} \hline 4.3 \\ 13.2 \end{gathered}$ | $\begin{aligned} & \hline \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |
| Io | Out. Sink Current (note 3) Segment OFF <br> Segment ON | $\begin{array}{\|l} \mathrm{V}_{\mathrm{O}}=3 \mathrm{~V} \\ \left.\mathrm{~V}_{\mathrm{O}}=1 \mathrm{~V} \text { (note } 4\right) \\ \text { Brightness In. }=0 \mu \mathrm{~A} \\ \text { Brightness In. }=100 \mu \\ \text { Brightness In. }=750 \mu \mathrm{~A} \end{array}$ | $\begin{gathered} 0 \\ 2 \\ 12 \end{gathered}$ | $\begin{aligned} & 27 \\ & 15 \end{aligned}$ | 10 <br> 10 <br> 4 <br> 25 | $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ <br> mA <br> mA |
| $\mathrm{f}_{\text {clock }}$ | Input Clock Frequency |  | 0 |  | 0.5 | MHz |
| Io | Output Matching (note 1) |  |  |  | $\pm 20$ | \% |

Note: 1. Output matching is calculated as the percent variation from $I_{\mathrm{MAX}}+\mathrm{I}_{\mathrm{MIN}} / 2$.
2. With a fixed resistor on the brightness input some variation in brightness will occur from one device to another.
3. Absolute maximum for each output should be limited to 40 mA .
4. The $\mathrm{V}_{\mathrm{O}}$ voltage should be regulated by the user. See Figure 7 and Figure 8 for allowable VO versus IO operation.

Figure 4. Input Data Format


Figure 5.


Figure 7.


Figure 6.


Figure 8.


## TYPICAL APPLICATIONS

Figure 9. Basic Electronically Tuned Radio Or Tv System


Figure 10. Duplexing 8 Digits With One M5450


## POWER DISSIPATION OF THE IC

The power dissipation of the IC can be limited using different configurations.
Figure 11- In the application R must be chosen taking into account the worst operating conditions.

Figure 11.

$R$ is determined by the maximum number of segments activated

$$
R=\frac{v_{C}-v_{\text {DMAX }}-v_{\text {OMIN }}}{N_{M A X} L_{D}}
$$

The worst case condition for the device is when roughly half of the maximum number of segments are activated.
It must be checked that the total power dissipation does not exceed the absolute maximum ratings of the device.
In critical cases more resistors can be used in conjunction with groups of segments.
In this case the current variation in the single resistor is reduced and $P_{\text {tot }}$ limited.
Figure 12 - In this configuration the drop on the serial connected diodes is quite stable if the diodes are properly chosen.

The total power dissipation of the IC depends, in a first approximation, only on the number of segments activated.

Figure 12.


Figure 13 - In this configuration $\mathrm{V}_{\text {OUT }}+\mathrm{V}_{\mathrm{D}}$ is constant. The total power dissipation of the IC depends only on the number of segments activated.

Figure 13.


## PART NUMBERING

Table 3. Order Codes

| Part Number | Package | Temperature Range |
| :---: | :---: | :---: |
| M5450B7/M5451B7 | PDIP40 | -25 to $85^{\circ} \mathrm{C}$ |
| M5451Q | PLCC44 | -25 to $85^{\circ} \mathrm{C}$ |

## PACKAGE MECHANICAL

Table 4. PDIP40 - Mechanical Data

| Symbol | millimeters |  |  | inches |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Typ | Min | Max | Typ | Min | Max |
| a1 |  | 0.63 |  |  | 0.025 |  |
| b |  | 0.45 |  |  | 0.018 |  |
| b1 | 0.23 |  | 0.31 | 0.009 |  | 0.012 |
| b2 |  | 1.27 |  |  | 0.050 |  |
| D |  |  | 52.58 |  |  | 2.070 |
| E | 15.2 |  | 16.68 | 0.598 |  | 0.657 |
| e |  | 2.54 |  |  | 0.100 |  |
| e3 |  | 48.26 |  |  | 1.900 |  |
| F |  |  | 14.1 |  |  | 0.555 |
| i |  | 4.445 |  |  | 0.175 |  |
| L |  | 3.3 |  |  | 0.130 |  |

Figure 14. PDIP40 - Package Dimensions


[^0]Table 5. PLCC44 - Mechanical Data

| Symbol | millimeters |  |  | inches |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Typ | Min | Max | Typ | Min | Max |
| A | 17.4 |  | 17.65 | 0.685 |  | 0.695 |
| B | 16.51 |  | 16.65 | 0.650 |  | 0.656 |
| C | 3.65 |  | 3.7 | 0.144 |  | 0.146 |
| D | 4.2 |  | 4.57 | 0.165 |  | 0.180 |
| d1 | 2.59 |  | 2.74 | 0.102 |  | 0.108 |
| d2 |  | 0.68 |  |  | 0.027 |  |
| E | 14.99 |  | 16 | 0.590 |  | 0.630 |
| e |  | 1.27 |  |  | 0.050 |  |
| e3 |  | 12.7 |  |  | 0.500 |  |
| F |  | 0.46 |  |  | 0.018 |  |
| F1 |  | 0.71 |  |  | 0.028 |  |
| G |  |  | 0.101 |  | 0.046 |  |
| M |  | 1.16 |  |  | 0.045 |  |
| M1 |  | 1.14 |  |  |  |  |

Figure 15. PLCC44 - Package Dimensions


Note: Drawing is not to scale.

## REVISION HISTORY

Table 6. Revision History

| Date | Revision | Description of Changes |
| :---: | :---: | :--- |
| September-1993 | 1 | First Issue |
| 14-Mar-2004 | 2 | Stylesheet update. No content change. |

Information furnished is believed to be accurate and reliable. However, STMicroelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of STMicroelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. STMicroelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of STMicroelectronics.

The ST logo is a registered trademark of STMicroelectronics.
All other names are the property of their respective owners
© 2004 STMicroelectronics - All rights reserved

STMicroelectronics GROUP OF COMPANIES
Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States
www.st.com


[^0]:    Note: Drawing is not to scale

